

## **TMD3700** Color, ALS and Proximity Sensor Module

### **General Description**

The device features advanced Proximity measurement, Digital Ambient Light Sensing (ALS) and Color Sensing (CRGB). The slim module incorporates an IR LED and factory calibrated LED driver. The Proximity detection feature provides object detection (e.g. mobile device screen to user's ear) by photodiode detection of reflected IR energy (sourced by the integrated LED).

Detect/release events are interrupt driven, and occur when proximity result crosses upper and/or lower threshold settings.

The proximity engine features offset adjustment registers to compensate for unwanted IR energy reflection at the sensor. Proximity results are further improved by automatic ambient light subtraction. The Color and ALS detection feature provides red, green, blue and clear light intensity data. Each of the C, R, G, B channels have a UV and IR blocking filters and a dedicated data converter producing16-bit data simultaneously. This architecture allows applications to accurately measure ambient light and sense color which enables devices to calculate illuminance and color temperature, control display backlight, and chromaticity.

Ordering Information and Content Guide appear at end of datasheet.

Figure 1: Added Value of Using TMD3700

Benefits	Features
<ul> <li>Reduced board space requirements and enables low-profile system design</li> </ul>	<ul> <li>Small footprint and low profile package 4.00 x 1.75 x 1.00 mm</li> </ul>
<ul> <li>Improved ALS angular response for more accurate measurement of lighting environment</li> </ul>	• 45 degree average ALS FOV
<ul> <li>Operating range of 200 milli-Lux to 60 kilo-Lux enables operation behind dark glass</li> </ul>	Wide dynamic range and high sensitivity

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Benefits	Features
Single device integrated optical solution	<ul> <li>RGB, Ambient Light Sensor (ALS) and proximity support</li> <li>Power management features</li> <li>I<sup>2</sup>C fast mode interface compatible</li> <li>Integral IR LED</li> </ul>
<ul> <li>Accurate color temperature and ambient light sensing</li> </ul>	<ul> <li>UV / IR blocking filters</li> <li>Programmable gain and integration time</li> </ul>
Reduced power consumption	<ul> <li>0.18µ process technology with 1.8V l<sup>2</sup>C bus</li> </ul>

## Applications

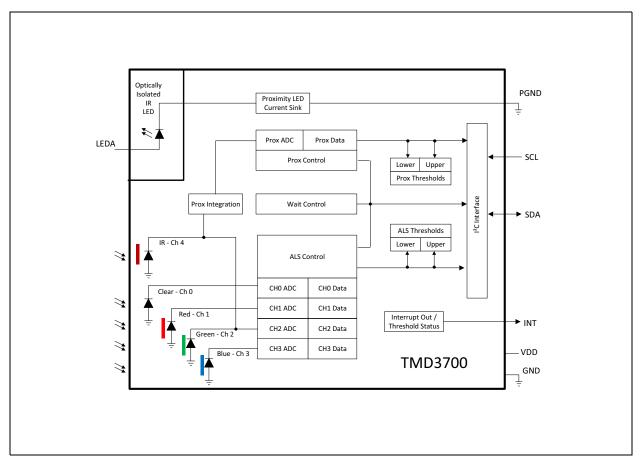
The TMD3700 applications include:

- Color Sensing
- Ambient Light Sensing
- Mobile Phone touch screen disable

## **Block Diagram**

The functional blocks of this device are shown below:

Figure 2: Functional Blocks of TMD3700

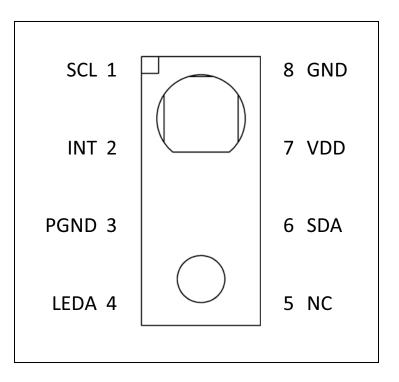




## **Pin Assignment**

#### Top View of module showing pin assignment

Figure 3: TMD3700 Pinout (Top View)



#### Figure 4: Pin Description

Pin Number	Pin Name	Description	
1	SCL	I <sup>2</sup> C serial clock input terminal	
2	INT	Interrupt. Open drain output (active low).	
3	PGND	Ground for LED current sink.	
4	LEDA	LED anode	
5	NC	No connection	
6	SDA	I <sup>2</sup> C serial data I/O terminal	
7	VDD	Supply voltage	
8	GND	Ground. All voltages are referenced to GND	



## Absolute Maximum Ratings

Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. These are stress ratings only. Functional operation of the device at these or any other conditions beyond those indicated under Recommended Operating Conditions is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

Figure 5:		
Absolute	Maximum	Ratings

Symbol	Parameter	Min	Мах	Units
VDD	Supply voltage	-0.3	2.2	V
LEDA	Supply voltage	-0.3	3.6	V
V <sub>IO</sub>	Digital I/O terminal voltage	-0.3	3.6	V
(SDA, INT)	Output terminal current	-1	20	mA
T <sub>Strg</sub>	Storage temperature range	-40 85		٥C
I <sub>SCR</sub>	Input current (latch up immunity) JEDEC JESD78D Nov 2011	CLASS 1		
ESD <sub>HBM</sub>	Electrostatic discharge HBM S-001-2014	±2000		V
ESD <sub>CDM</sub>	Electrostatic discharge CDM JEDEC JESD22-C101F Oct 2013	±	500	V

## **Electrical Characteristics**

Figure 6:

**Recommended Operating Conditions** 

Symbol	Parameter	Min	Тур	Мах	Units
V <sub>DD</sub>	Supply voltage	1.7	1.8	2.0	V
V <sub>LEDA</sub>	Voltage supplied to LEDA pin	3.0 <sup>(2)</sup>	3.3	3.6	V
T <sub>A</sub>	Operating free-air temperature <sup>(1)</sup>	-30		85	°C

#### Note(s):

1. While the device is operational across the temperature range, performance will vary with temperature. Operational characteristics are at 25°C, unless otherwise noted.

2. Minimum VLED for pldrive of 100mA or less.

Figure 7:

Operating Characteristics,  $V_{DD} = 1.8 V$ ,  $T_A = 25^{\circ}C$  (unless otherwise noted)

Symbol	Parameter	Conditions	Min	Тур	Max	Units
f <sub>OSC</sub>	Oscillator frequency			8.0		MHz
		Active ALS state (PON=AEN=1, PEN= 0) <sup>(2)</sup>	20	90	150	μΑ
IDD	Supply current <sup>(1)</sup>	Idle state (PON=1, AEN=PEN=0) <sup>(3)</sup>		30	60	μ
		Sleep state <sup>(4)</sup>		0.7	5.0	μΑ
VOL	INT, SDA output low voltage	6 mA sink current			0.6	V
ILEAK	Leakage current, SDA, SCL, INT, pins	Leakage current at $0V = \pm 50nA$ Leakage current at $3V = \pm 50nA$	-50		50	nA
VIH	SCL, SDA input high voltage		1.26			V
VIL	SCL, SDA input low voltage				0.54	V
T <sub>ACTIVE</sub>	Time from power-on to ready to receive I <sup>2</sup> C commands			1.5		ms

#### Note(s):

1. Values are shown at the VDD pin and do not include current through the IR LED.

2. This parameter indicates the supply current during periods of ALS integration. If Wait is enabled (WEN=1), the supply current is lower during the Wait period.

3. Idle state occurs when PON=1 and all functions are not enabled.

4. Sleep state occurs when PON = 0 and I<sup>2</sup>C bus is idle. If Sleep state has been entered as the result of operational flow, SAI = 1, PON will remain high.

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#### Figure 8: Optical Characteristics

Parameter	Test Conditions	Clear Channel			Units
Farameter		Min	Тур	Max	Units
	$\lambda_D = 465 \text{ nm LED}, 53.8 \ \mu\text{W/cm}^2$		112		
	$\lambda_D = 530 \text{ nm LED}, 43.9 \mu\text{W/cm}^2$		152		count/(µW/cm <sup>2</sup> )
Re	$\lambda_D = 620 \text{ nm LED, } 37.5 \mu\text{W/cm}^2$		193		count/(µw/cm )
Irradiance responsivity	Warm white LED, 45.6 $\mu$ W/cm <sup>2</sup>		152		
settings: AGAIN = 16x	Warm white LED, 45.6 $\mu$ W/cm <sup>2</sup>	5950	7000	8050	counts
ATIME = 400mS		IR Channel			
		Min	Тур	Max	
	$\lambda_D = 950 \text{ nm LED, } 21.1 \mu\text{W/cm}^2$		137		count/(µW/cm <sup>2</sup> )

### Figure 9:

ALS Operating Characteristics, VDD = 1.8 V,  $T_A = 25$  °C, AGAIN = 16x, ATIME = 0xF6 (unless otherwise noted)

Parameter	Conditions	Min	Тур	Мах	Units
Integration time step size		2.68	2.78	2.90	ms
Dark ADC count value	Ee = 0 μW/ cm <sup>2</sup> AGAIN: 64x ATIME: 100ms (0xDC)	0	1	3	counts
	AGAIN: 4x		4		
Gain scaling, relative to 1x gain setting	AGAIN: 16x		16		х
	AGAIN: 64x		64		
ADC noise	AGAIN: 16x		0.005		% full scale
Lux accuracy <sup>(1)</sup>	White LED, 2700K	90	100	110	%

#### Note(s):

1. Not production tested. Representative result by laboratory characterization.

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## Figure 10:

## **Proximity Operating Characteristics**

Parameter	Conditions	Min	Тур	Max	Units
Part to part variation <sup>(1)</sup>	Conditions: PGAIN = 2 (4x) PLDRIVE = 8 (54mA) PPULSE = 15 (16 pulses) PPULSE_LEN = 1 (8 $\mu$ s) d=23mm round target 30mm target distance	75	100	125	%
Response, absolute	Basic proximity measurement Conditions: PGAIN = 2 (4x) PLDRIVE = 16 (102mA) PPULSE = 15 (16 pulses) PPULSE_LEN = 2 (16µs) Target material: 90% reflective surface of Kodak gray card Target Size: 100mm x 100mm Target Distance: 100mm Module held by TMD37003SH210T socket	90	113	136	counts
	Improved accuracy proximity measurement using factory programmed offsets in each device and a supplied driver	85	100	115	
Response, no target using offset values from 0xE6 and 0xE7	PGAIN = 2 (4x) ILEDDRIVE = 16 (102mA) PPULSE = 16 (17 Pulses) Pulse Length = 2 (16µs)	0		12	counts
Noise/Signal <sup>(3)</sup>	PGAIN = 2 (4x) IRLEDDRIVE = 8 (54mA) PPULSE = 15 (16 pulses) PPULSE_LEN = 1 (8µs) d=23mm round target 30mm target distance			1	%

#### Note(s):

1. Production tested result is the average of 5 readings expressed relative to a calibrated response.

2. Representative result by characterization.

3. Production tested result is the average of 20 readings divided by the average response.



Figure 11: Spectral Response

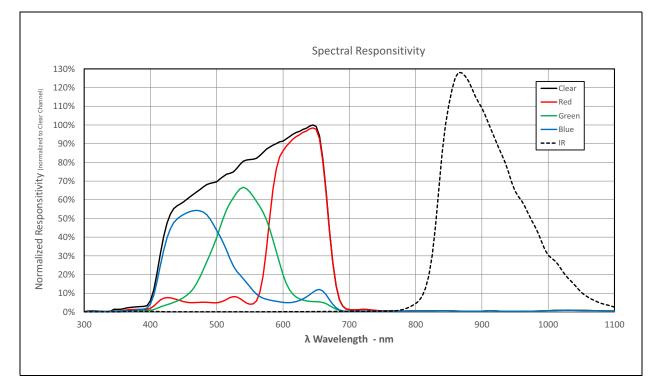
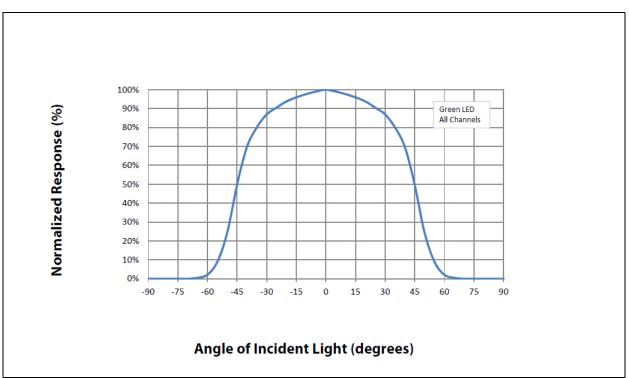


Figure 12: ALS Average Angular Response





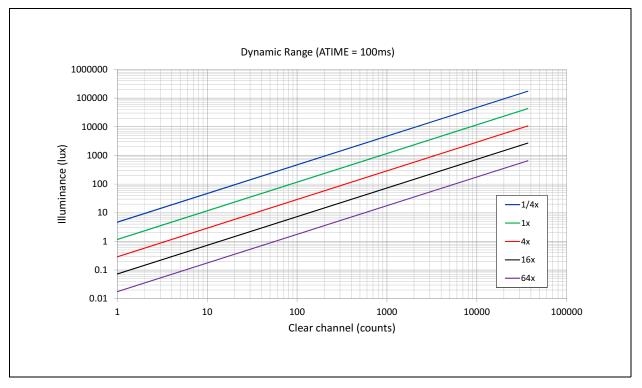
#### Figure 13: CRGB Optical Characteristics

Parameter	Test Conditions	Red / Clear Channel		Green / Clear Channel		Blue / Clear Channel	
		Min	Max	Min	Max	Min	Мах
	$\lambda_D = 465 \text{ nm}$	0%	20%	0%	55% <sup>(1)</sup>	80%	100%
Color ADC count value ratio: color / clear	$\lambda_D = 525 \text{ nm}$	0%	30% <sup>(1)</sup>	65%	90%	0%	50% <sup>(1)</sup>
	$\lambda_D = 615 \text{ nm}$	80%	110%	0%	20%	0%	20%
	White LED, 2700 k	50%	70%	24%	45%	10%	35%

#### Note(s):

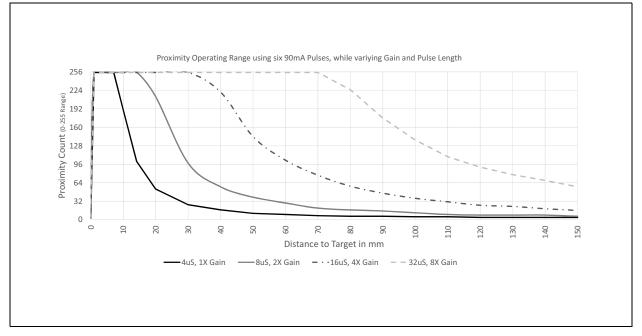
1. Not production tested.

Figure 14: Illuminance (Lux) vs Counts (Clear Channel)



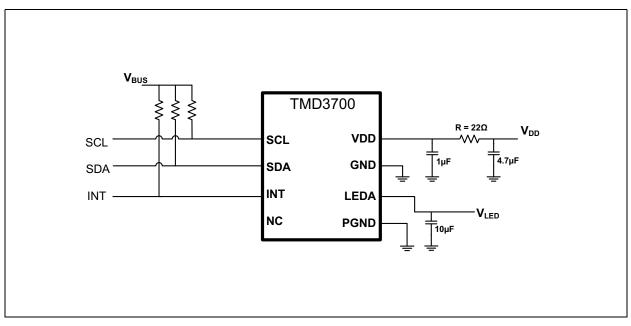


#### Figure 15: Proximity Operation



By varying Gain, LED drive current, number of LED pulses and LED pulse duration the proximity detection range can be adjusted.

#### Figure 16: Proximity Test Circuit



#### Note(s):

1. Place the  $1\mu F$  and  $10\mu F$  capacitors as close as possible to the module.

2.  $V_{\text{DD}}$  = 1.8V,  $V_{\text{BUS}}$  = 1.8V,  $V_{\text{LED}}$  = 3.3V.

## I<sup>2</sup>C Protocol

The device uses I<sup>2</sup>C serial communication protocol for communication. The device supports 7-bit chip addressing and both standard and full-speed clock frequency modes. Read and Write transactions comply with the standard set by Philips (now NXP).

Internal to the device, an 8-bit buffer stores the register address location of the desired byte to read or write. This buffer auto-increments upon each byte transfer and is retained between transaction events (I.e. valid even after the master issues a STOP command and the I<sup>2</sup>C bus is released). During consecutive Read transactions, the future/repeated I<sup>2</sup>C Read transaction may omit the memory address byte normally following the chip address byte; the buffer retains the last register address +1.

All 16-bit fields have a latching scheme for reading and writing. In general it is recommended to use I<sup>2</sup>C bursts whenever possible, especially in this case when accessing two bytes of one logical entity. When reading these fields, the low byte must be read first, and it triggers a 16-bit latch that stores the 16-bit field. The high byte must be read immediately afterwards. When writing to these fields, the low byte must be written first, immediately followed by the high byte. Reading or writing to these registers without following these requirements will cause errors.

## I<sup>2</sup>C Write Transaction

A Write transaction consists of a START, CHIP-ADDRESSWRITE, REGISTER-ADDRESS WRITE, DATA BYTE(S), and STOP. Following each byte (9TH clock pulse) the slave places an ACKNOWLEDGE/NOT- ACKNOWLEDGE (ACK/NACK) on the bus. If NACK is transmitted by the slave, the master may issue a STOP.

### I<sup>2</sup>C Read Transaction

A Read transaction consists of a START, CHIP-ADDRESSWRITE, REGISTER-ADDRESS, RESTART, CHIP-ADDRESSREAD, DATA BYTE(S), and STOP. Following all but the final byte the master places an ACK on the bus (9TH clock pulse). Termination of the Read transaction is indicated by a NACK being placed on the bus by the master, followed by STOP.

The  $l^2C$  bus protocol was developed by Philips (now NXP). For a complete description of the  $l^2C$  protocol, please review the NXP  $l^2C$  design specification.



## **Register Description**

Figure 17: Register Overview

0x80ENABLER/WEnables states and interrupts0x000x81ATIMER/WADC integration time0x000x82PRATER/WProximity sample rate0x1F0x83WTIMER/WWait time0x000x84ALTLR/WALS interrupt low threshold low byte0x000x86AILTHR/WALS interrupt low threshold high byte0x000x86AILTHR/WALS interrupt low threshold low byte0x000x87AIHTHR/WALS interrupt high threshold low byte0x000x88PILTR/WALS interrupt high threshold low byte0x000x88PILTR/WProximity interrupt high threshold0x000x88PILTR/WProximity interrupt high threshold0x000x86PERSR/WValL Long0x800x87CFG0R/WWait Long0x800x88PCFG1R/WProximity pulse width and count0x800x88PCFG1R/WConfiguration register one0x000x90CFG1R/WConfiguration register one0x000x91REVIDRClear ADC low data register0x000x93STATUSR, SCDevice ID0x000x94CDATALRClear ADC low data register0x000x95CDATAHRGreen ADC low data register0x000x96RDATALRGreen ADC high data register0x000x98BDATAL	Address	Register Name	R/W	Register Function	Reset Value
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Ox9A     BDATAL     R     Blue ADC low data register     Ox00       0x9B     BDATAH     R     Blue ADC high data register     0x00       0x9C     PDATA     R     Proximity ADC data register MSBs     0x00	0x98	GDATAL	R	Green ADC low data register	0x00
Ox9B     BDATAH     R     Blue ADC high data register     Ox00       0x9C     PDATA     R     Proximity ADC data register MSBs     0x00	0x99	GDATAH	R	Green ADC high data register	0x00
0x9C     PDATA     R     Proximity ADC data register MSBs     0x00	0x9A	BDATAL	R	Blue ADC low data register	0x00
	0x9B	BDATAH	R	Blue ADC high data register	0x00
0x9F CFG2 R/W LSB of ALS gain 0x04	0x9C	PDATA	R	Proximity ADC data register MSBs	0x00
	0x9F	CFG2	R/W	LSB of ALS gain	0x04

# amu

Address	Register Name	R/W	Register Function	Reset Value
0xAB	CFG3	R/W	R/W Configuration register three	
0xC0	POFFSET_L	R/W	Proximity offset magnitude	0x00-0xFF
0xC1	POFFSET_H	R/W	Proximity offset sign	0x00-0xFF
0xD7	CALIB	R/W	Calibration control	0x00
0xD9	CALIBCFG	R/W	Calibration configuration	0x00
0xDC	CALIBSTAT	R/W	Calibration status bit	0x00
0xDD	INTENAB	R/W	Interrupt enables	0x00

#### Note(s):

• R = Read Only

• W = Write Only

- R/W = Read or Write
- SC = Self Clearing after access



## **ENABLE Register (0x80)**

Figure 18: ENABLE Register

	0x80: ENABLE								
Field	Name	Reset	Туре	Description					
7:4	Reserved	0	RW	Reserved.					
3	wen	0	RW	Wait Enable. This bit activates the wait feature. Writing a one actives the wait timer. Writing a zero disables the wait timer.					
2	pen	0	RW	Proximity Detect Enable. This field activates the proximity detection.					
1	aen	0	RW	ALS Enable. This bit actives the ALS function. Set aen=1 and pon=1 in the same command to ensure autozero function is run prior to the first measurement.					
0	pon	0	RW	Power ON. This field activates the internal oscillator to permit the timers and ADC channels to operate. Writing a one activates the oscillator. Writing a zero disables the oscillator.					

The Mode/Parameter fields should be written before aen or pen is asserted. The functions pen and aen require pon to be asserted for the respective function to operate correctly.

#### ATIME Register (0x81)

Figure 19: ATIME Register

0x81: ATIME									
Field	Name	Reset	Туре		Description				
			0x00 RW	Integration Time. Eight bit value that specifies the integration time in 2.81ms intervals. 0x00 indicates 2.8ms, 0x01 indicates 5.6ms. The maximum ALS value depends on the integration time. For every 2.81ms, the maximum value increases by 1024. This means that to be able to reach ALS full scale, the integration time has to be at least 64*2.8ms.					
				Value	Integration Cycles	Integration Time	Maximum ALS Value		
7:0	atime	0x00		0x00	1	2.8ms	1023		
				0x01	2	5.6ms	2047		
				0x3f	63	180ms	65535		
				0xff	255	721ms	65535		

The ATIME register controls the integration time of the ALS ADCs.

The timer is implemented with a down counter with 0x00 as the terminal count. The timer is clocked at a 2.8ms nominal rate. Loading 0x00 will generate a 2.8ms integration time, loading 0x01 will generate a 5.6ms integration time, and so forth.

**Note(s):** The RC oscillator runs at 8MHz nominal rate. This gets divided by 11 to generate the integration clock of 727kHz. One count in ATIME (nominal 2.8ms) are 2.81ms. This is 2048 integration clock cycles: 125ns\*11\*8\*256=2.81ms.



### PRATE Register (0x82)

Figure 20: PRATE Register

0x82: PRATE							
Field	Name	Reset	Туре	Description			
7:0	PRATE	0x1F	RW	This register defines the duration of 1 Prox Sample, which is (PRATE + 1)*88µs			

### WTIME Register (0x83)

Figure 21: WTIME Register

	0x83: WTIME									
Field	Name	Reset	Туре	Description						
			ALS Wait Time. Eight bi between ALS cycles.	ALS Wait Time. Eight bit value that specifies the time in 2.81ms to wait between ALS cycles.						
				Value	Wait Cycles	Wait Time				
	7:0 wtime 0x00 R <sup>1</sup>		0x00	1	2.8ms/ 33.8ms					
7:0		0x00	) RW	0x01	2	5.6ms/ 67.6ms				
				0x3f	63	180ms/ 2.16s				
			0xff	255	721ms/ 8.65s					

The wait timer is implemented with a down counter with 0x00 as the terminal count. Loading 0x00 will generate a 2.81ms wait time, loading 0x01 will generate a 5.6ms wait time, and so forth; by asserting wlong, in register 0x8D the wait time is given in multiples of 33.8ms (12x).

#### AILTL Register (0x84)

#### Figure 22: AILTL Register

0x84: AILTL								
Field	Name	Reset	Туре	Description				
7:0	AILTL	0x00	RW	Low Byte of the Low Threshold				

This register provides the low byte of the low interrupt ALS (C channel) threshold.

#### AILTH Register (0x85)

Figure 23: AILTH Register

0x85: AILTH						
Field	Name	Reset	Туре	Description		
7:0	AILTH	0x00	RW	High Byte of the Low Threshold		

This register provides the high byte of the low interrupt ALS (C channel) threshold.

The contents of the AILTH and AILTL registers are combined and treated as a sixteen bit threshold. If the value generated by the C channel is below the low threshold specified and the APERS value is reached, the aint bit is asserted which will assert the INT pin if aien is set.

There is an 8-bit data latch implemented that stores the written low byte until the high byte is written. Both bytes will be applied then at the same time to avoid an invalid threshold (e.g. when going from 0x00ff to 0x0100, the invalid intermediate value 0x0000 is suppressed. This implies that 1) the LSB cannot be changed without writing to the MSB and 2) that writing to the LSB of one 16-bit value and afterwards to the MSB of another 16-bit register will write all 16 bits to the MSB related register.



#### AIHTL Register (0x86)

#### Figure 24: AIHTL Register

0x86: AIHTL							
Field	Name	Reset	Туре	Description			
7:0	AIHTL	0	RW Low Byte of the High Threshold				

This register provides the low byte of the high interrupt threshold.

#### AIHTH Register (0x87)

Figure 25: AIHTH Register

	0x87: AIHTH								
Field	Name	Reset	Туре	Description					
7:0	AIHTH	0	RW	High Byte of the High Threshold					

This register provides the low byte of the high interrupt threshold.

The contents of the AIHTH and AIHTL registers are combined and treated as a sixteen bit threshold. If the value generated by the C channel is above the high threshold specified and the APERS value is reached, the aint bit is asserted which will assert the INT pin if aien is set.

#### PILT Register (0x88)

#### Figure 26: PILT Register

0x88: PILT						
Field	Name	Reset	Туре	Description		
7:0	pilt	0	RW	Proximity ADC Channel Low Threshold		

This register provides the low interrupt threshold.

If the value generated by the proximity channel is below the low threshold specified and the PPERS value is reached, the pint bit is asserted which will assert the INT pin if pien is set.

#### PIHT Register (0x8A)

Figure 27: PIHT Register

0x8A: PIHT						
Field	Name	Reset	Туре	Description		
7:0	piht	0	RW	Proximity ADC Channel High Threshold		

This register provides the high interrupt threshold.

If the value generated by the proximity channel is above the high threshold specified and the PPERS value is reached, the pint bit is asserted which will assert the INT pin if pien is set.



## PERS Register (0x8C)

Figure 28: PERS Register

				0x8C: PEF	RS		
Field	Name	Reset	Туре		Description		
				Proximity Persistence Filtering.			
				Value	Interrupt generated when		
				0	Every proximity cycle		
7:4	ppers	0	RW	1	Any proximity value outside of threshold range		
	ppers	Ŭ		2	2 consecutive proximity values out of range		
				3	3 consecutive proximity values out of range		
				15	15 consecutive proximity values out of range		
				Value	Interrupt generated when		
				0	Every ALS cycle		
				1	Any ALS value outside of threshold range		
				2	2 consecutive ALS values out of range		
				3	3 consecutive ALS values out of range		
				4	5		
3:0	apers	0	RW	5	10		
				6	15		
				7	20		
				12	45		
				13	50		
				14	55		
				15	60 consecutive ALS values out of range		

### CFG0 Register (0x8D)

Figure 29: CFG0 Register

	0x8D: CFG0							
Field	Name	Reset	Туре	Description				
7:3	Reserved	10000	RW	Reserved. Must be set to 10000.				
2	wlong	0	RW	Wait Long. When asserted, the wait cycle is increased by a factor 12x from that programmed in the WTIME register.				
1:0	Reserved	0 0	RW	Reserved. Must be set to 00.				

This register controls the interrupt filtering capabilities of the device. Configurable filtering is provided to allow interrupts to be generated after either a proximity or ALS integration cycle or if the integration cycle has produced a result that is outside of the values specified by threshold register for some specified number of times. Separate filtering is provided for proximity and ALS functions.

ALS interrupts are generated by looking only at the ADC integration results of the C channel photodiode.

#### PCFG0 Register (0x8E)

Figure	30:
PCFG0	Register

	0x8E: PCFG0							
Field	Name	Reset Type Description						
	7:6 ppulse_len		RW	Proximity Pulse Length.				
		1		Value	Pulse Length			
7.6				0	4µs			
7.0				1	8µs			
			2	16µs				
				3	32µs			

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	0x8E: PCFG0						
Field	Name	Reset	Туре	Description			
			Maximum Number of Pulses ir	n Proximity.			
				Value	Number of Pulses		
5:0 ppulse	15	RW	0	1			
			1	2			
			2	3			
				63	64		

## PCFG1 Register (0x8F)

Figure 31: PCFG1 Register

	0x8F: PCFG1							
Field	Name	Reset	Туре	Description				
				Proximity Gain Control. Sets the	gain of the proximity receiver.			
				Value	Gain Value			
7:6	pgain	2	RW	0	1x			
7.0	pgan	2	IVV	1	2x			
				2	4x			
				3	8x			
5	Reserved	0	RW	Reserved.				
				Proximity LED Drive Strength. Th of 6mA This is the nominal value. trim procedure.				
			RW	Value	LED Current			
4:0	pldrive	0		0	6mA			
				1	12mA			
			31	192mA				

## CFG1 Register (0x90)

#### Figure 32: CFG1 Register

	0x90: CFG1								
Field	Name	Reset	Туре	Descr	iption				
7:2	Reserved	0	RW	Reserved.					
			RW	ALS Gain Control. Sets the	e gain of the ALS DAC.				
		0		Field Value	Gain				
1:0	again			00	1x				
1.0	again			01	4x				
				10	16x				
				11	64x				

**CFG1 Register:** Register CFG1 sets the gain level for ALS measurements. The valid range of values is 0x00 - 0x03.

## **REVID Register (0x91)**

Figure 33: REVID Register

	0x91: REVID							
Field	Field Name Reset Type		Туре	Description				
7:4	Reserved	0000	R	Reserved.				
3	Reserved	0	R	Reserved.				
2:0	rev_id	010	R	Revision Number Identification				



## ID Register (0x92)

#### Figure 34: ID Register

0x92: ID						
Field	Name	ne Reset Type Description				
				Part Number Identification.		
7:2	ID	110000	R	Value	Meaning	
			110000			
1:0	Reserved			Reserved.		

## STATUS Register (0x93)

Figure 35: STATUS Register

			0×	93: STATUS
Field	Name	Reset	Туре	Description
7	asat	0	R, SC	ALS Saturation. This flag is set for analog saturation writing a 1 will clear this status flag; to enable clear-by-read function, the register CFG3.int_read_clear must be set 1
6	psat	0	R, SC	Proximity Saturation. Indicates that an ambient- or reflective-saturation event occurred during a previous proximity cycle. writing a 1 will clear this status flag; to enable clear-by-read function, the register CFG3.int_read_clear must be set 1
5	pint	0	R, SC	Proximity Interrupt. Indicates that the device is asserting a proximity interrupt. writing a 1 will clear this status flag; to enable clear-by-read function, the register CFG3.int_read_clear must be set 1
4	aint	0	R, SC	ALSIntr. Indicates that the device is asserting an ALS interrupt. writing a 1 will clear this status flag; to enable clear-by-read function, the register CFG3.int_read_clear must be set 1
3	cint	0	R, SC	Calibration Interrupt. writing a 1 will clear this status flag; to enable clear-by-read function, the register CFG3.int_read_clear must be set 1
1	psat_ reflective	0	R, SC	psat interrupt is from reflective light saturation writing a 1 to psat or psat_reflective will clear this status flag; to enable clear-by-read function, the register CFG3.int_read_clear must be set 1

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	0x93: STATUS						
Field	Name	Reset	Туре	Description			
0	psat_ ambient	0	R, SC	psat interrupt is from ambient light or idac threshold saturation writing a 1 to psat or psat_ambient will clear this status flag; to enable clear-by-read function, the register CFG3.int_read_clear must be set 1			

STATUS flags are reset with reading from STATUS address, or with writing 1 to dedicated bits of STATUS address.

## CDATAL Register (0x94)

Figure 36: CDATAL Register

	0x94: CDATAL						
Field	Name	Reset	Туре	Description			
7:0	CDATAL	0	RO	Low Byte of C Channel Data. If pcap_calib is active, then low byte of this result is stored here			

### CDATAH Register (0x95)

Figure 37: CDATAH Register

	0x95: CDATAH						
Field	Name	Reset	Туре	Description			
7:0	CDATAH	0	RO	High Byte of C Channel Data. If pcap_calib is active, then high byte of this result is stored here			

## **RDATAL Register (0x96)**

Figure 38: RDATAL Register

	0x96: RDATAL					
Field	Name	Reset	Туре	Description		
7:0	RDATAL	0	RO	Low Byte of R Channel Data.		



### **RDATAH Register (0x97)**

Figure 39: RDATAH Register

0x97: RDATAH						
Field	Name	Reset	Туре	Description		
7:0	RDATAH	0	RO	High Byte of R Channel Data.		

### **GDATAL Register (0x98)**

Figure 40: GDATAL Register

	0x98: GDATAL						
Field	Name	Reset	Туре	Description			
7:0	GDATAL	0	RO	Low Byte of G Channel Data.			

### **GDATAH Register (0x99)**

Figure 41: GDATAH Register

	0x99: GDATAH							
Field	Name	Reset	Туре	Description				
7:0	GDATAH	0	RO	High Byte of G Channel Data.				

## **BDATAL Register (0x9A)**

Figure 42: BDATAL Register

0x9A: BDATAL					
Field	Name	Reset	Туре	Description	
7:0	BDATAL	0	RO	Low Byte of B Channel Data.	

## BDATAH Register (0x9B)

#### Figure 43: BDATAH Register

0x9B: BDATAH							
Field	Name	Reset	Туре	Description			
7:0	BDATAH	0	RO	High Byte of B Channel Data.			

## PDATA Register (0x9C)

Figure 44: PDATA Register

0x9C: PDATA						
Field	Name	Reset	Туре	Description		
7:0	PDATA	0	RO	Prox ADC Data MSB 9:2		



## CFG2 Register (0x9F)

#### Figure 45: CFG2 Register-ALS Gain

	0x9F: CFG2						
Field	Name	Reset	Туре	Description			
7:3	Reserved	0	RW	Reserved. Set to 0.			
2	againl	1	RW	This is the LSB of gain_als (gain_als[0]) Overall ALS Gain Control. If this bit is set to 0 then all gains are divided by 2 (except, in case ltf_gainmax is set).			
1:0	Reserved	0	RW	Reserved. Set to 0.			

Figure 46:

ALS Attenuation Settings

ALS Gain Settings						
Gain	again[1]	again[0]	againl			
Gain	0x90.1	0x90.0	0x9F.2			
1	0	0	1			
4	0	1	1			
16	1	0	1			
64	1	1	1			

## CFG3 Register (0xAB)

#### Figure 47: CFG3 Register

	0xAB: CFG3							
Field	Name	Reset Type		Description				
7	int_read_clear	0	RW	If set to 1, interrupt flags in STATUS register (0x93) are reset after I <sup>2</sup> C reads to the STATUS register; otherwise the interrupt flags will not be reset.				
6:5	Reserved	0	R, SC	Reserved	l. Set to 0.			
4	sai	0	RW	of the progenerate Note that	oximity/Al d. t SAI does	LS cycle if an inten not modify any	the device at the end errupt has been register bits directly, it urn OFF the oscillator. Oscillator OFF ON ON	
				1	1	0	OFF (SAI induced sleep)	
						up" the device fro upt register 0x93	om SAI-sleep is by	
3:0	Reserved	0	RW	Reserved	l. Set to 0.			

## POFFSET\_L Register (0xC0)

Figure 48: POFFSET\_L Register

0xC0: POFFSET_L						
Field	Name	Reset	Туре	Description		
7:0	poffset_l	0	R, SC	Offset compensation for proximity channel (magnitude)		



## POFFSET\_H Register (0xC1)

Figure 49: POFFSET\_H Register

	0xC1: POFFSET_H						
Field	Name	Reset	Туре	Description			
0	poffset_h	0	R, SC	Offset compensation for proximity channel (sign)			

## CALIB Register (0xD7)

Figure 50: CALIB Register

	0xD7: CALIB								
Field	Name	Reset	Туре	Description					
7:6	Reserved	0	RO	Reserved. Set to 0.					
5	electrical_calibration	0	RW_SM	If set, do electrical offset calibration (diodes disabled) instead of optical. Otherwise, do optical calibration. In either case, the result is stored in the POFFSET_L/H registers. This flag is cleared after calibration is completed This flag is redundant, software could just: set gdiode_disab=0xf set concap_intinn=1 start calibration However, since electrical calibration is done automatically at the first time PON gets asserted, the function is there anyway, so it's made availabe to the user here.					
4:1	Reserved	0	WS_SC	Reserved. Set to 0.					
0	start_offset_calib	0	RW_SM	Start Offset Calibration. The result is stored in the POFFSET registers. The calib_finished flag is asserted afterwards. Calibration can be stopped by writing a 0 to this bit.					

## CALIBCFG Register (0xD9)

#### Figure 51: CALIBCFG Register

0xD9: CALIBCFG								
Field	Name	Reset	Туре	Description				
				ADC target during binary s	search			
				Value	Target			
				0	0			
				1	1			
				2	3			
	binsrch_target	'h2	RW	3	7			
				4	15			
7:5				5	31			
7.5	billsten_target	112	IVV	6	63			
				7	127			
							Note that this target is rela In the circuit, a 10-bit target lowest 2 bits are always ign zero during binary search In hardware, this defines a ignore when comparing to binsrch_target=4 (target= from the ADC are AND'ed comparing to zero. Only va taken as positive ADC valu	t is used (x4) of which the nored when checking for and zero detection. mask of which bits to zero. E.g. 15) means that values with 0xffc0 before alues 16 or larger are
4	Reserved	1	RW	Reserved. Set to 0.				

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	0xD9: CALIBCFG							
Field	Name	Reset	Туре	Description				
				Prox data calculation is do consecutive windows of co the window, PDATA is upd HRM measurement	onstant size. At the end of			
				Value	Window Size			
	prx_data_avg	0	R_PUSH	0	disable			
				1	2			
2:0				2	4			
2.0	prx_data_avg	0	N_1 0511	3	8			
				4	16			
				5	32			
				6	64			
				7	128			
				Out to be useful, we will re production version.	eset this bit to zero in the			

## CALIBSTAT Register (0xDC)

Figure 52: CALIBSTAT Register

0xDC: CALIBSTAT						
Field	Name	Reset	Туре	Description		
0	calib_finished	0	R/W	Offset calibration has finished. Clear bit by writing '1' to it. Bit generates interrupt if cien is asserted.		

## INTENAB Register (0xDD)

#### Figure 53: INTENAB Register

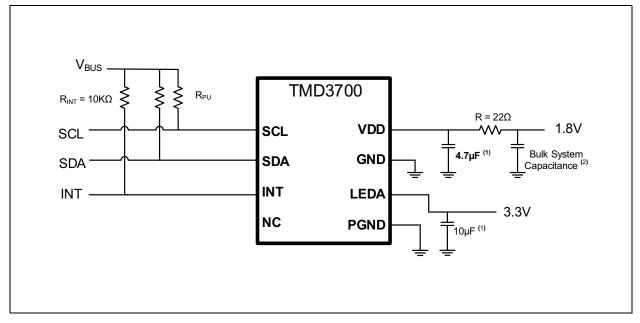
	0xDD: INTENAB						
Field	Name	Reset	Туре	Description			
7	asien	0	RW	Writing '1' to this bit enables asat interrupt.			
6	psien	0	RW	Writing '1' to this bit enables psat			
5	pien	0	RW	Writing '1' to this bit enables prox interrupt.			
4	aien	0	RW	Writing '1' to this bit enables als interrupt.			
3	cien	0	RW	Writing '1' to this bit enables calibration interrupt.			



## **Application Information**

Figure 54:

**Typical Application Hardware Circuit** 



#### Note(s):

1. Place the  $4.7\mu F$  and  $10\mu F$  capacitors as close as possible to the module.

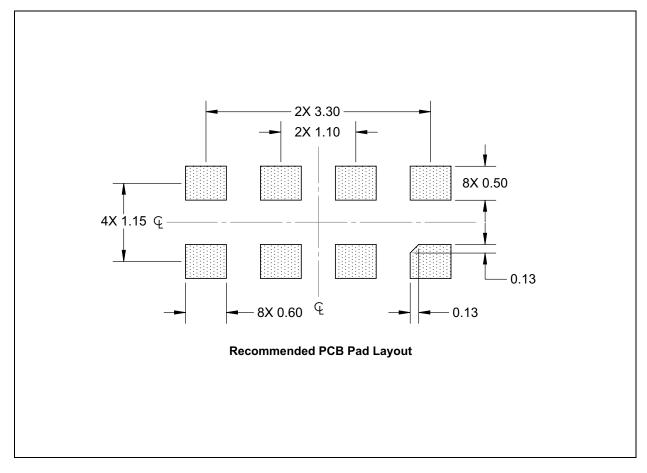
2. The bulk capacitor can affect the stability of a regulated supply output and should be chosen with the regulator characteristics in mind. In systems with a clean power supply the  $4.7\mu$ F and  $22\Omega$  resistor may not be needed.

- 3. The value of the  $l^2C$  pull up resistors  $R_{PU}$  should be based on the 1.8V bus voltage, system bus speed and trace capacitance.
- 4. GND and PGND should be connected to the same solid ground plane as close to the device as possible.



## PCB Pad Layout

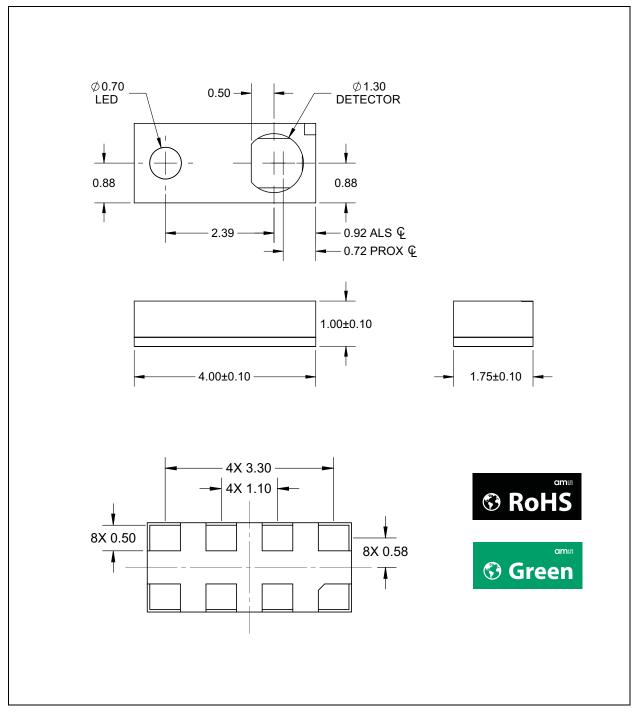
Figure 55: Recommended PCB Pad Layout





## **Packaging Mechanical Data**

Figure 56: Package Drawing



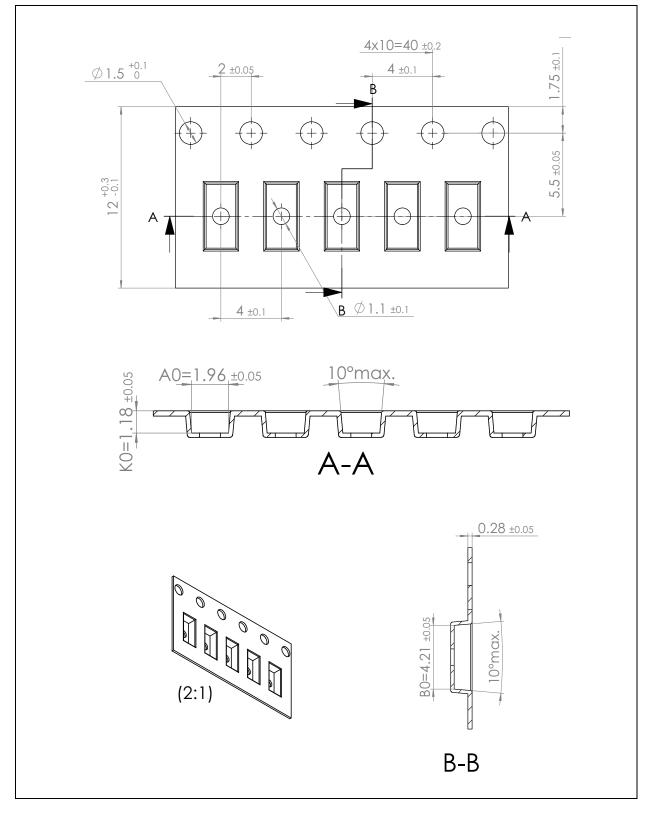
#### Note(s):

- 1. All linear dimensions are in millimeters.
- 2. The ALS detector is centered in the opening within a tolerance of  $\pm 0.03$  millimeters.
- 3. Contact finish is AU.
- 4. This drawing is subject to change without notice.



## **Tape & Reel Information**

#### Figure 57: Tape & Reel Information



#### Note(s):

1. All linear dimensions are in millimeters.

2. This drawing is subject to change without notice.



## Soldering & Storage Information

The module has been tested and has demonstrated an ability to be reflow soldered to a PCB substrate.

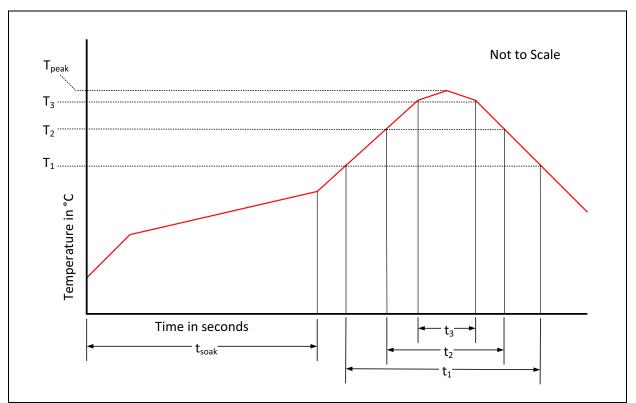
The solder reflow profile describes the expected maximum heat exposure of components during the solder reflow process of product on a PCB. Temperature is measured on top of component. The components should be limited to a maximum of three passes through this solder reflow profile.

Figure 58: Solder Reflow Profile

Parameter	Reference	Device
Average temperature gradient in preheating		2.5°C/s
Soak time	t <sub>soak</sub>	2 to 3 minutes
Time above 217°C (T <sub>1</sub> )	t <sub>1</sub>	Max 60s
Time above 230°C (T <sub>2</sub> )	t <sub>2</sub>	Max 50s
Time above T <sub>peak</sub> – 10 °C (T <sub>3</sub> )	t <sub>3</sub>	Max 10s
Peak temperature in reflow	T <sub>peak</sub>	260°C
Temperature gradient in cooling		Max –5°C/s

#### Figure 59:

**Solder Reflow Profile Graph** 



#### **Storage Information**

#### **Moisture Sensitivity**

Optical characteristics of the device can be adversely affected during the soldering process by the release and vaporization of moisture that has been previously absorbed into the package. To ensure the package contains the smallest amount of absorbed moisture possible, each device is baked prior to being dry packed for shipping.

Devices are dry packed in a sealed aluminized envelope called a moisture-barrier bag with silica gel to protect them from ambient moisture during shipping, handling, and storage before use.

#### Shelf Life

The calculated shelf life of the device in an unopened moisture barrier bag is 12 months from the date code on the bag when stored under the following conditions:

- Shelf Life: 12 months
- Ambient Temperature: <40°C
- Relative Humidity: <90%

Rebaking of the devices will be required if the devices exceed the 12 month shelf life or the Humidity Indicator Card shows that the devices were exposed to conditions beyond the allowable moisture region.

#### Floor Life

The module has been assigned a moisture sensitivity level of MSL 3. As a result, the floor life of devices removed from the moisture barrier bag is 168 hours from the time the bag was opened, provided that the devices are stored under the following conditions:

- Floor Life: 168 hours
- Ambient Temperature: <30°C
- Relative Humidity: <60%

If the floor life or the temperature/humidity conditions have been exceeded, the devices must be rebaked prior to solder reflow or dry packing.

#### **Rebaking Instructions**

When the shelf life or floor life limits have been exceeded, rebake at 50°C for 12 hours.



## **Ordering & Contact Information**

Figure 60: Ordering Information

Ordering Code	I <sup>2</sup> C Bus	I <sup>2</sup> C Address	Delivery Form	Delivery Quantity
TMD37003	1.8V	39h	Tape & Reel (13")	10000 pcs/reel
TMD37003M	1.8V	39h	Tape & Reel (7")	1000 pcs/reel
TMD37007 <sup>(1)</sup>	1.8V	29h	Tape & Reel (13")	10000 pcs/reel

#### Note(s):

1. Consult factory for availability of secondary address versions.

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## **Document Status**

Document Status	Product Status	Definition
Product Preview	Pre-Development	Information in this datasheet is based on product ideas in the planning phase of development. All specifications are design goals without any warranty and are subject to change without notice
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## **Revision Information**

Changes from 1-01 (2016-Jun-27) to current revision 1-02 (2016-Aug-19)	Page
Removed POFFEST Magnitude and POFFSET Sign registers	
Updated Figure 7	5
Updated Figure 17	12

#### Note(s):

1. Page and figure numbers for the previous version may differ from page and figure numbers in the current revision.

2. Correction of typographical errors is not explicitly mentioned.

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